

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chu-Yin Tseng	06/28/2007
Shih-Chieh Hsu	06/28/2007
Chih-Chiang Wu	06/28/2007
Shyh-Fann Ting	06/28/2007
Po-Lun Cheng	06/28/2007
Hsuan-Hsu Chen	06/28/2007
RECEIVING PARTY DATA	
Name:	UNITED MICROELECTRONICS CORP.
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park
City:	Hsin-Chu City
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12781826
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NAME OF SUBMITTER:	JANINE CHANG

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Total Attachments: 3
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ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Chu-Yin Tseng Nationality: R.O.C.

Name: Shih-Chieh Hsu Nationality: R.O.C.

Name: Chih-Chiang Wu Nationality: R.O.C.

Name: Shyh-Fann Ting Nationality: R.O.C.

Name: Po-Lun Cheng Nationality: R.O.C.

Name: Hsuan-Hsu Chen Nationality: R.O.C.

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: UNITED MICROELECTRONICS CORP.

Address: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"Method of fabricating metal oxide semiconductor transistor"

Which is found in :

(a) + U.S. patent application executed on even date

(b) _____ U.S. patent application executed on _____

(c) _____ U.S. application serial no. _____

(d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this JUN 28 2007 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Chu-Yin Tseng

Chu Yin Tseng

Shih-Chieh Hsu

Shih-Chieh Hsu

Chih-Chiang Wu

Chih-Chiang Wu

Shyh-Fann Ting

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Po-Lun Cheng

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